T-1 3/4 (5mm) INFRARED EMITTING DIODE

Part Number: L-7113SF7C

Features

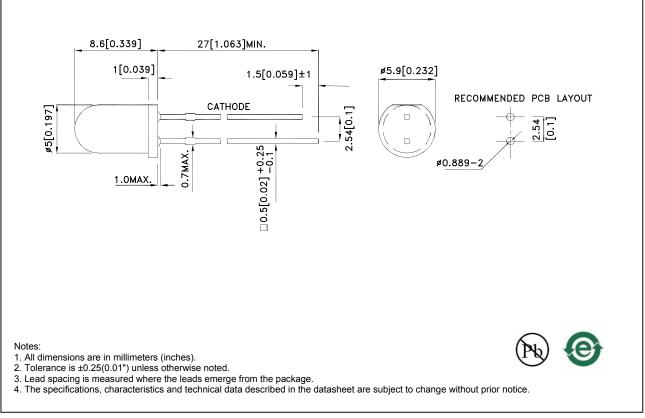
• Mechanically and spectrally matched to the phototransistor.

• RoHS compliant.

Description

SF7 Made with Gallium Aluminum Arsenide Infrared Emitting diodes.

Package Dimensions



REV NO: V.16B CHECKED: Allen Liu DATE: JUL/11/2014 DRAWN: L.Q.Xie PAGE: 1 OF 6 ERP: 1101006708

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| Selection Guide | | | | | | |
|-----------------|--------------|-------------|--------------------------------|------|----------------------|--|
| Part No. | Dice | Lens Type | Po (mW/sr) [2] @ 20mA *50mA | | Viewing Angle [1] | |
| | | | Min. | Тур. | 201/2 | |
| L-7113SF7C | SF7 (GaAlAs) | Water Clear | 12 | 30 | 20° | |
| | | | *40 | *90 | | |

Notes:

01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
* Radiant intensity with asterisk is measured at 50mA;Radiant Intensity/ luminous flux: +/-15%.
Radiant intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

| Parameter | P/N | Symbol | Тур. | Max. | Units | Test Conditions |
|--------------------------|-----|--------|------|------|-------|-----------------|
| Forward Voltage [1] | SF7 | VF | 1.4 | 1.6 | V | I⊧=20mA |
| Reverse Current | SF7 | lr | | 10 | uA | VR = 5V |
| Capacitance | SF7 | С | 30 | | pF | VF=0V;f=1MHz |
| Peak Spectral Wavelength | SF7 | λP | 850 | | nm | I⊧=20mA |
| Spectral Bandwidth | SF7 | Δλ1/2 | 50 | | nm | I⊧=20mA |

Note:

1. Forward Voltage: +/-0.1V.

2. Wavelength value is traceable to the CIE127-2007 compliant national standards.

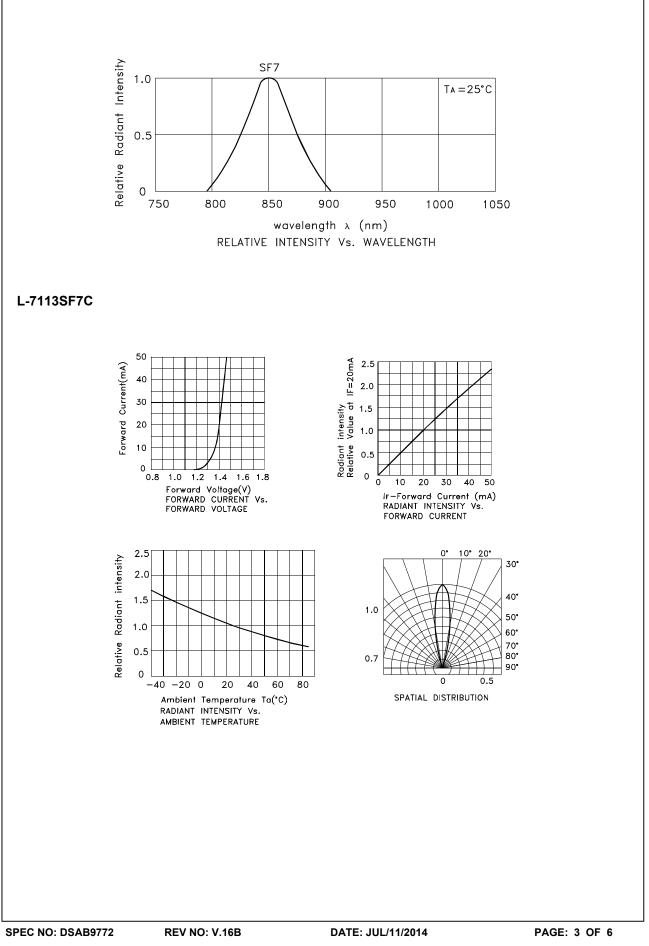
Absolute Maximum Ratings at TA=25°C

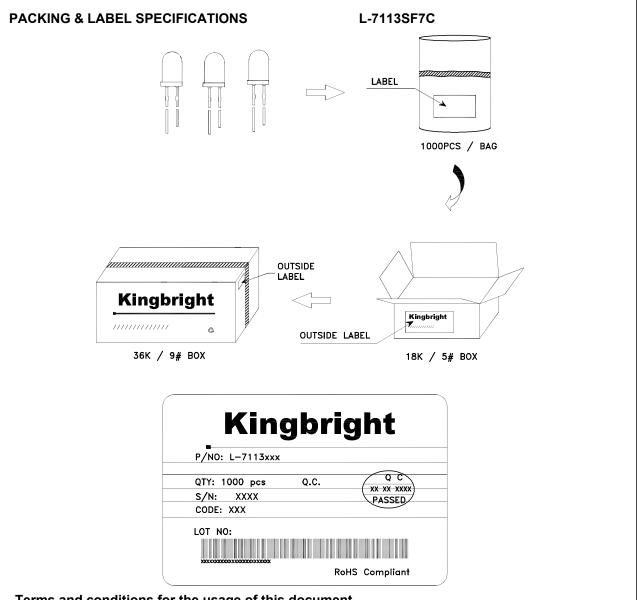
| Parameter | Symbol | SF7 | Units | | |
|-----------------------------|---------------------|------------|-------|--|--|
| Power dissipation | Po | 80 | mW | | |
| DC Forward Current | lF | 50 | mA | | |
| Peak Forward Current [1] | İFS | 1 | А | | |
| Reverse Voltage | VR | 5 | V | | |
| Operating Temperature | Та | -40 To +85 | °C | | |
| Storage Temperature | Тятд | -40 To +85 | °C | | |
| Lead Solder Temperature [2] | 260°C For 3 Seconds | | | | |
| Lead Solder Temperature [3] | 260°C For 5 Seconds | | | | |

Notes:

1. 1/100 Duty Cycle, 10µs Pulse Width.

2. 2mm below package base.
3. 5mm below package base.



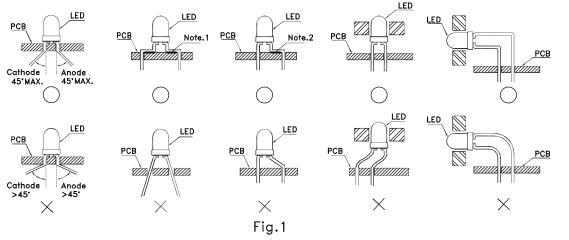


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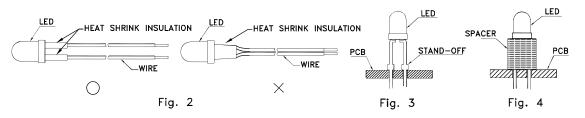
PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)

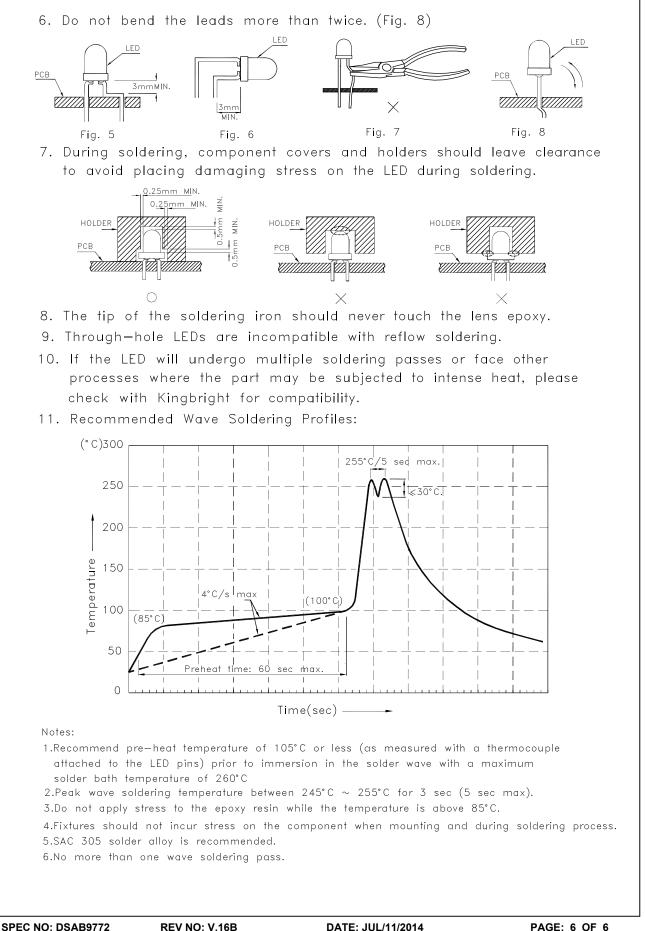


")" Correct mounting method "imes" Incorrect mounting method

- When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit. (Fig.2)
- 3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



- 4. Maintain a minimum of 3mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)



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